

# UG10241

## MCUXpresso 安全配置快速入门指南

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User guide

### Document information

Information	Content
Keywords	MCUXpresso 安全配置工具
Abstract	MCUXpresso Secure Provisioning Tool (SEC, MCUXpresso 安全配置工具) 是一个旨在简化 NXP MCU 平台上可启动的可执行文件的生成和配置过程的 GUI 工具。它建立在由 NXP 提供的、经验证的且成熟稳定的安全特性部署工具集之上，并利用了 BootROM 提供的丰富的编程接口。



## 1 概述

本快速入门指南提供了分步概述，帮助您高效地安装、配置和开始使用MCUXpresso安全配置工具。无论您是安全启动和加密工作流程的新手，还是希望将安全配置集成到生产流程中，本指南都将帮助您快速入门。

MCUXpresso安全配置工具（SEC工具）是NXP开发的强大实用工具，用于简化嵌入式设备的安全配置。该工具设计用于支持广泛的NXP微控制器，使开发人员能够配置安全功能、生成加密密钥，并以最少的设置步骤安全地对设备进行编程。

## 2 硬件要求

- 建议从NXP的参考设计板（FRDM/EVK）开始。
- 启动MCUXpresso安全配置工具的详细要求列在 [MCUXpresso Secure Provisioning Tool Release Notes](#) 中。

## 3 软件要求

MCUXpresso安全配置工具可以在Windows、Linux或MacOS上执行。详细要求列在 [MCUXpresso Secure Provisioning Tool Release Notes](#) 中。

## 4 安装和配置SEC工具

MCUXpresso安全配置工具安装程序适用于Windows、Linux或MacOS，可从 [NXP Secure Provisioning web](#) 下载。对于Windows和MacOS，安装程序作为向导工作，逐步指导您完成安装过程。Linux提供Debian包。有关安装的详细信息可以在 [MCUXpresso Secure Provisioning Tool User Guide](#) 中找到。

## 5 使用工具

### 5.1 先决条件

作为工具的输入，使用在处理器上工作的应用程序二进制文件（S19、HEX、ELF/AXF或BIN文件格式）。根据启动设备，为RAM或Flash构建应用程序。建议从任何MCUXpresso SDK示例开始，该示例已为正确的地址预配置。在使用MCUXpresso安全配置工具之前，在调试器中运行应用程序并检查其是否按预期工作。

对于FRDM和EVK板，提供了二进制形式的示例应用程序，通常会闪烁板载LED。即使您还没有任何特定的应用程序，也可以使用它来评估工具功能。

要将应用程序加载到板中，请将板切换到系统内编程（ISP）模式。有关如何执行此操作的详细信息，请查看板的文档或处理器的参考手册。

### 5.2 新工作区

当您首次启动MCUXpresso安全配置工具时，它会要求您创建一个新的工作区，即包含项目所需所有文件的文件夹。您也可以稍后使用命令创建新工作区：主菜单 > 文件 > 新建工作区。

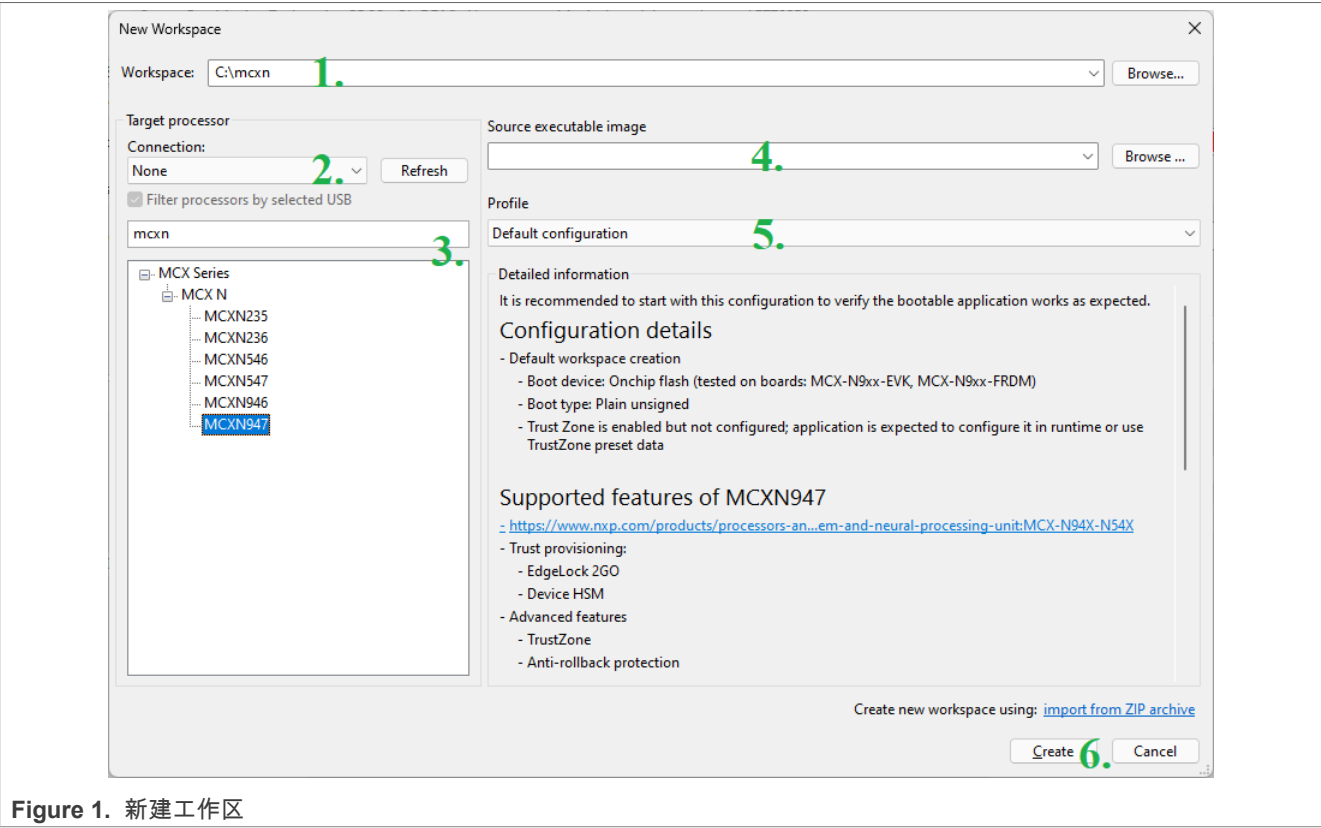


Figure 1. 新建工作区

要创建工作区，请填写以下参数：

1. 选择磁盘上的工作区路径。建议为每个项目创建一个新文件夹。
2. 将设备连接到计算机并选择使用的连接，如UART COM端口或USB。使用USB连接允许工具自动选择处理器系列。
3. 直接从树形列表中选择处理器或使用搜索栏。
4. 选择应用程序的路径作为源可执行镜像文件。  
注意：对于NXP板，该工具包含可从下拉列表中选择的预编译SDK示例。
5. 要验证应用程序的构建和写入过程，请使用默认配置文件，即应用程序代码未签名且为明文（未加密）。稍后，当您已经在工具中测试了应用程序时，可以选择安全配置文件，工具会生成密钥并为安全启动预生成配置。
6. 点击创建按钮创建工作区。

### 5.3 工具GUI

创建工作区后，将显示工具主窗口。主窗口包含：

1. 主菜单
2. 工具栏
3. “构建所有镜像文件”、“写入镜像文件”和“PKI管理”选项卡
4. 日志视图
5. 状态行

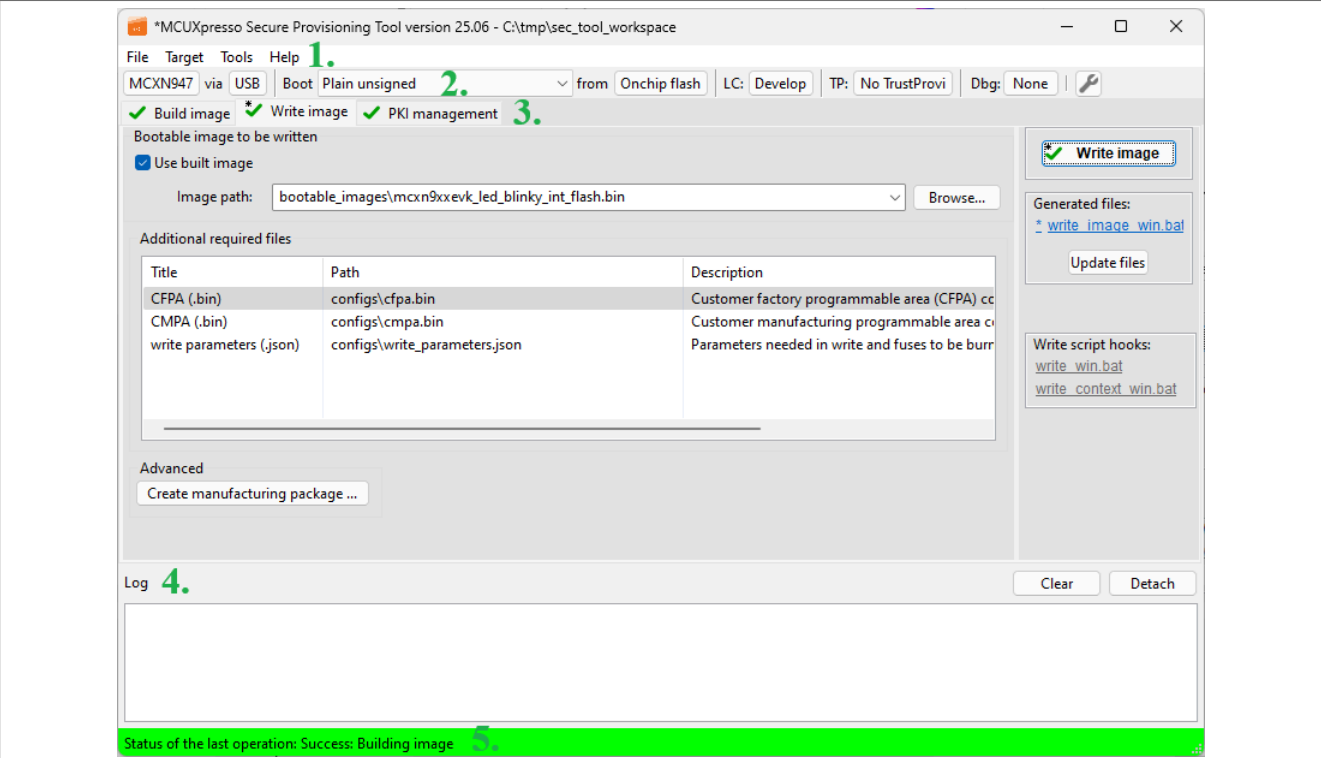


Figure 2. 工具GUI

第一步，请仔细检查工具栏上的配置是否符合您的要求。您将在那里找到：

1. 选定的处理器（已在向导中选择）
2. 连接方式（已在向导中选择）
3. 启动模式（已在向导中选择）
4. 启动内存
5. 生命周期（建议从默认值开始）
6. 信任配置（建议从默认值开始）
7. 调试探针（对于大多数处理器，您不需要这个；它可能用于设置用于代替熔丝的影子寄存器）
8. 快速修复按钮

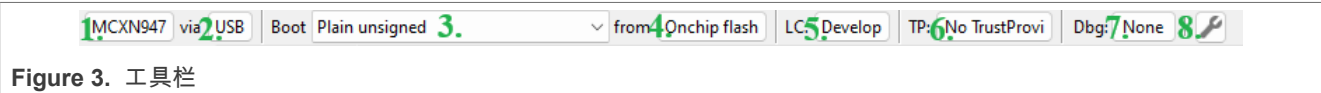


Figure 3. 工具栏

### 5.4 检查连接

使用命令主菜单 > 目标 > 连接或点击工具栏中的连接按钮，在连接配置对话框中选择测试连接按钮。这会ping ISP模式下的处理器并检查是否可以建立连接。如果连接成功建立，对话框会显示连接的检测状态。

如果连接不工作，请检查板是否配置为ISP/SDP模式并重置板。

### 5.5 构建可启动 镜像文件

如果您使用向导创建工作区，构建页面上应该没有任何错误。错误以红色显示，问题描述显示在工具提示中，因此如果有任何错误指示，请修复它们。注意：忽略写入页面上的错误，在您构建镜像文件之前会有错误。

点击构建镜像文件按钮构建可启动镜像文件。进度显示在日志中。如果有任何问题，请阅读日志并修复它。作为过程一部分生成的文件显示在按钮下方。最重要的列为第一个。它被称为“build\_image”脚本，是在构建过程中执行的脚本。可以点击它并检查内容。

## 5.6 测试可启动镜像文件

一旦构建了可启动镜像文件，您可以继续到写入镜像文件页面并将其写入启动内存。仔细检查没有报告错误，然后点击写入镜像文件按钮开始该过程。写入过程的工作方式类似于构建过程。它将进行预检查，如果没有发现问题，将生成写入脚本。如果写入脚本对处理器进行任何不可逆的更改，GUI会显示确认对话框，其中包含更改列表。之后，执行写入脚本，详细信息列在日志视图中。

应用程序写入后，请验证它是否正确启动（从ISP切换到RUN模式并重置）。

## 5.7 下一步

一旦您有了一个工作的可启动应用程序，就可以添加其他安全配置，例如：

- 使用签名或加密镜像文件的安全启动
- 双镜像文件启动
- 防回滚配置
- 一次性可编程（OTP）配置
- 等等

建议在每次更改后检查应用程序。如果应用程序无法启动，请恢复并找出导致问题的更改。该工具提供各种检查以防止无效配置。错误（红色）是阻塞问题，以防止将任何无效配置应用于处理器。警告（黄色）是不寻常/不推荐的设置，但它们是非阻塞的。

当应用程序的安全配置最终确定并稳定后，您就可以进入生产阶段了。该工具可以生成制造包 - 一个包含生产所需所有文件的ZIP文件。在制造设施中，导入包并应用（制造工具允许并行应用到多个板）。

## 5.8 特定处理器工作流程

部分处理器有其专属特性需要进行配置。这就是为什么在 [MCUXpresso Secure Provisioning Tool User Guide](#) 的“处理器特定工作流程”部分中描述了处理器特定工作流程，其中包含如何配置不同安全配置的分步过程。

# 6 参考资料

## 6.1 Release Notes

[https://docs.mcuxpresso.nxp.com/secure/latest/release\\_notes.html](https://docs.mcuxpresso.nxp.com/secure/latest/release_notes.html)

*MCUXpresso Secure Provisioning Tool Release Notes* (document MCUXSPTRN)

## 6.2 User Guide

[https://docs.mcuxpresso.nxp.com/secure/latest/01\\_introduction.html](https://docs.mcuxpresso.nxp.com/secure/latest/01_introduction.html)

*MCUXpresso Secure Provisioning Tool User Guide* (document MCUXSPTUG)

## 6.3 NXP Secure Provisioning web

<https://nxp.com/mcuxpresso/secure>

6.4 Community, forum, knowledge base

<https://community.nxp.com/t5/MCUXpresso-Secure-Provisioning/tkb-p/mcux-secure-tool>

7 修订历史

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